



MSD10065G1 Automotive 650V Silicon Carbide Schottky Diode

Features

- -650-Volt Schottky Rectifier
- -Shorter recovery time
- -High-speed switching possible
- -High-Frequency Operation
- -Temperature-Independent Switching Behavior
- -Extremely Fast Switching
- -Positive Temperature Coefficient on VF

Benefits

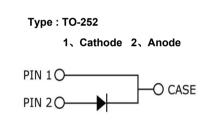
- -Higher safety margin against overvoltage
- -Improved efficiency all load conditions
- -Increased efficiency compared to Silicon Diode alternatives
- -Reduction of Heat Sink Requirements
- -Parallel Devices Without Thermal Runaway
- -Essentialy No Switching Losses

Applications

-Switch Mode Power Supplies -Power Factor Correction -Motor Drives -HID Lighting



Package



Absolute Maximum Ratings $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	MSD10065G1	Units
VRRM	Repetitive Peak Reverse Voltage	650	V
VRSM	Surge Peak Reverse Voltage	650	V
VDC	DC Blocking Voltage	650	V
IF	Continuous Forward Current @Tc=150°C	10	А
IFRM	Repetitive Peak Forward Surge Current @TC=25 ℃ tp = 10 ms, Half Sine Wave	80	A
IFSM	Non-Repetitive Peak Forward Surge Current @TC=25 [°] C tp= 10 ms, Half Sine Wave	105	А
IFSM	Non-Repetitive Peak Forward Surge Current @TC=25 °C, tp= 10 us, pulse	840	A
Ptot	Power Dissipation @Tc=25°C @Tc=110°C	138 60	W
TJ , Tstg	Operating Junction and Storage Temperature	-55 to +175	°C

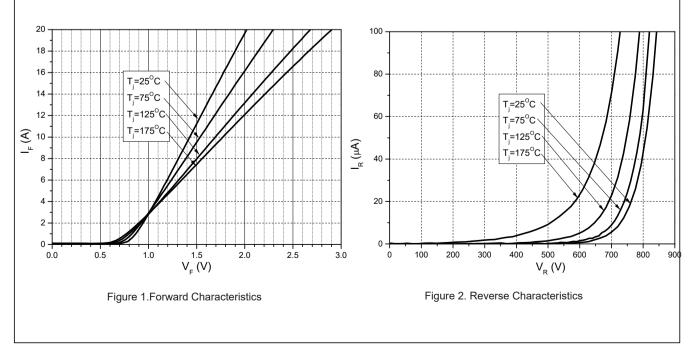
MSD10065G1

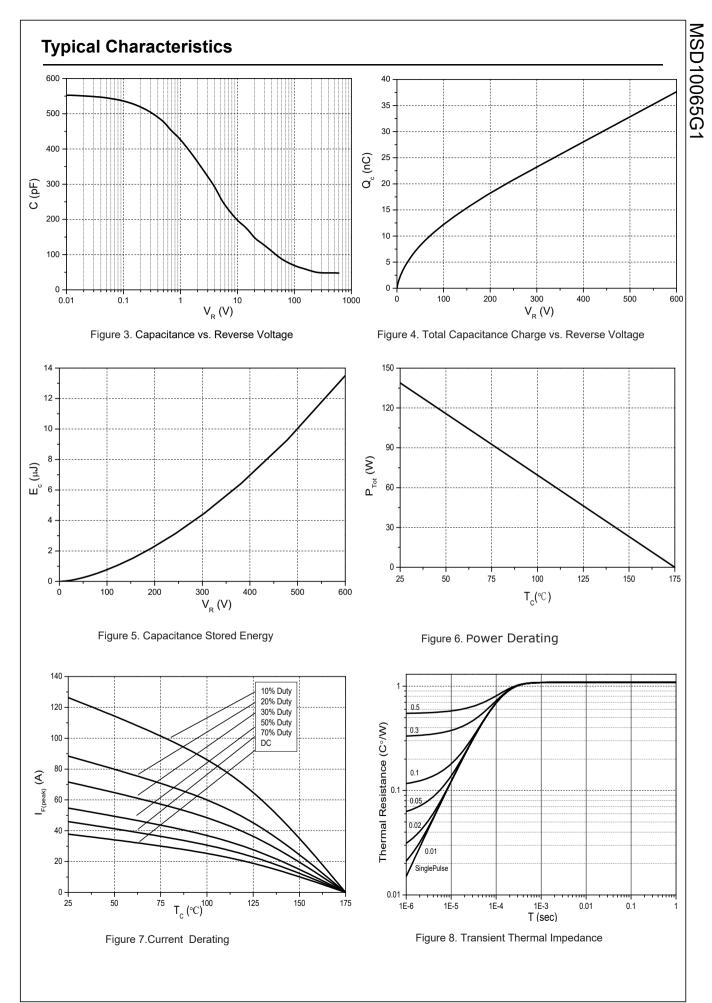
Electrical Characteristics T _c = 25° C unless otherwise noted						
Symbol	Test Conditions	Test Conditions	Min	Тур	Мах	Unit
VF	Forward Voltage	IF=10A, TC=25°C IF=10A, TC=175°C	-	1.45 1.75	1.7 2.00	V
IR	Reverse Current	VR=650V, TC=25°C VR=650V, TC=175°C	-	2 40	20 200	μΑ
QC	Total Capacitive Charge	VR =400V, IF =10A TJ = 25° C Qc= $\int_0^{\nu_r} C (V) dv$	-	28	-	nC
С	Total Capacitance	VR =0V, TJ = 25°C, f=1MHz VR =200V, TJ = 25°C, f=1MHz VR =400V, TJ = 25°C, f=1MHz	-	550 53 48	-	pF
EC	Capacitance Stored Energy	VR=400V	-	7.0	-	μJ

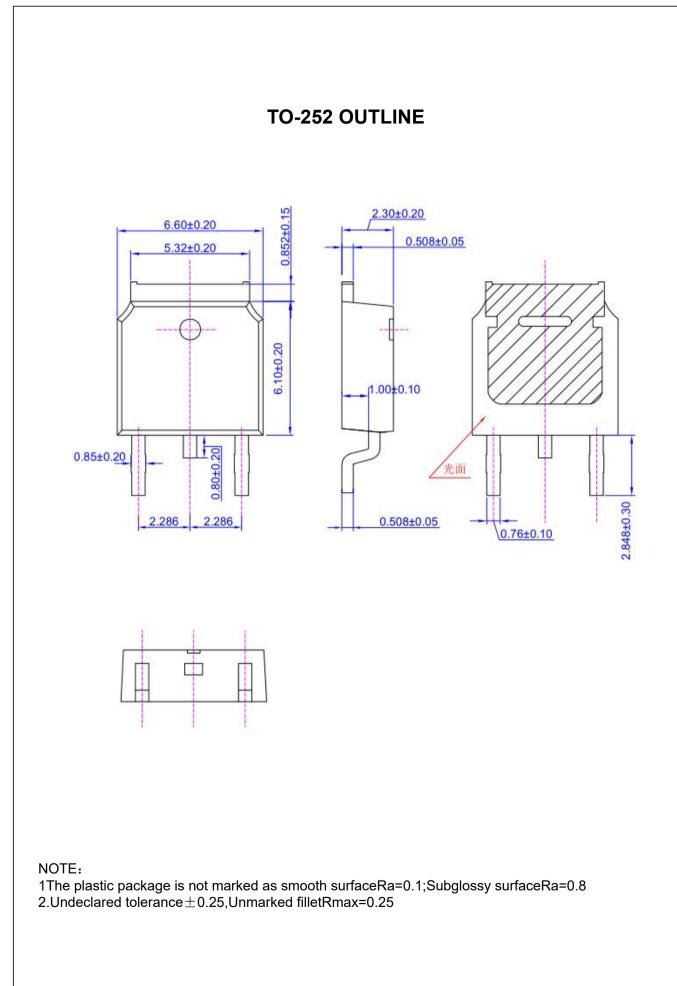
Thermal Characteristics

Symbol	Parameter	Тур	Unit
RθJC	Thermal Resistance from Junction to Case		°C/W









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